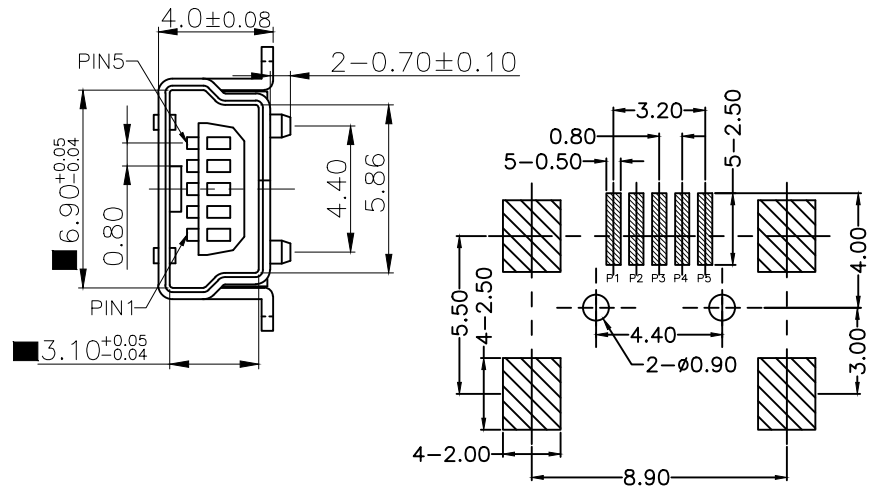
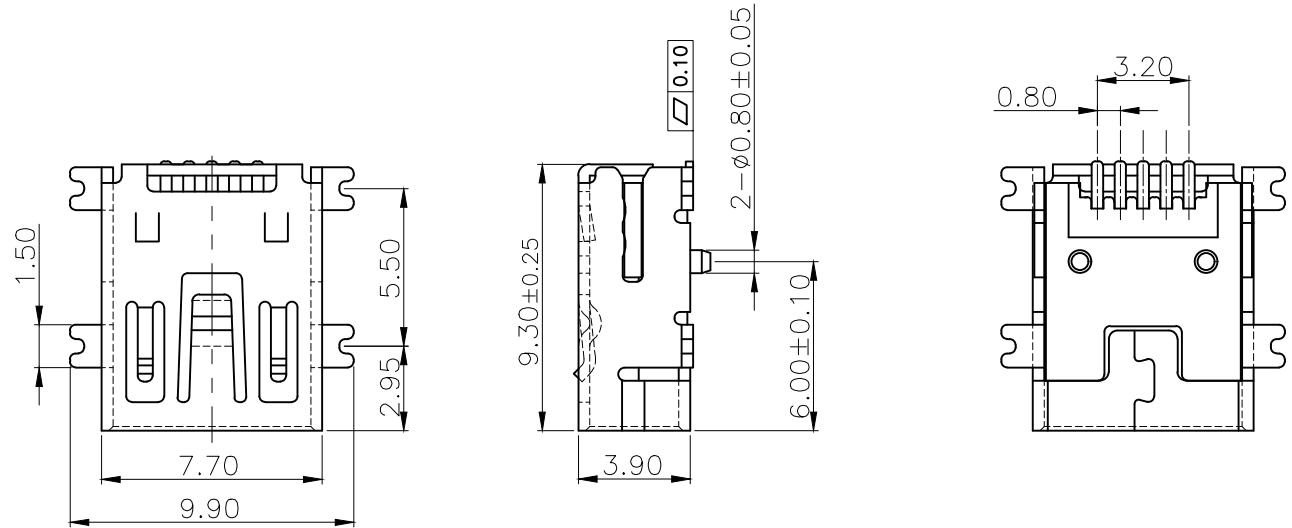
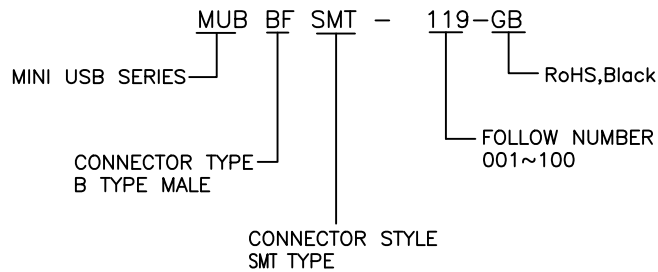


RoHS Compliant

NOTE:

1. Material:
Housing: LCP Black,UL94V-0;
Contact: Copper Alloy
Shell: Copper Alloy
2. Finish:
Contact: Gold Flash Plated on Contact Area,
80u" Min.Tin Plated on Solder Tails Area,
50u" Min.Nickel Underplating Over All.
Shell: 50u" Min.Nickel Underplating Over All.
3. Specification:
3.1: Voltage Current Rating:1.0 AMP. 30V/AC
Insulation Resistance:
100MΩ Min. at 100V/DC for 1Minute.
Withstanding voltage: 100 VAC/minute
Contact Resistance: 50mΩ Max.
Temperature Range:-20℃ to +85℃
4. Ordering information



RECOMMENDED PCB LAYOUT(TOP VIEW)
GENERAL TOLERANCES:±0.05

Shell	Color	Plating	Housing	Packing	P/N
Copper Alloy	Black	G/F	LCP	卷装	MUB BF SMT-119-GB

單位 UNIT	MM	*. Inspection Item	HJ-Tech 东莞市皇捷通讯科技有限公司
比例 SCALE	1:1	CP: Cp/Cpk and SPC Control Item	手机: 15015262131 手机: 13714786106
張數 SHEET	1*1	TOLERANCE UNLESS OTHERWISE SPECIFIED	圖號 DWG NO.
製圖 DRAWN	CLH	XXX±0.25 XXX±0.3	2LS00P0014
版本 REV.	NEW	XXX±0.20 XXX±0.1	名稱 TITLE
	設變內容 MODIFICATION	XXX±0.10 XXX±	MINI USB 5P SMT普通款 (定位柱0.70)
	日期 DATE	核准 APPROVE	角法 PROJ.
	修改 DRAW	審核 CHECKED	客户图